

## Terms and Conditions of Software Evaluation License

This Terms and Conditions of Software Evaluation License (the “**Agreement**”) is legally binding contract between Renesas Electronics Corporation (“**RENESAS**”) and you (“**Customer**”).

IT IS IMPORTANT THAT YOU READ CAREFULLY AND UNDERSTAND THIS AGREEMENT. BY CLICKING ON THE “I ACCEPT” BUTTON OR MECHANISM DESIGNED TO ACKNOWLEDGE AGREEMENT TO THE TERMS OF AN ELECTRONIC COPY OF THIS AGREEMENT, OR BY DOWNLOADING, INSTALLING OR OTHERWISE USING THE SOFTWARE, YOU AGREE TO BE BOUND BY THIS AGREEMENT. IF YOU DO NOT AGREE WITH ALL THE TERMS OF THIS AGREEMENT AND DO NOT AGREE TO BE BOUND BY THIS AGREEMENT, YOU SHALL EXIT WITHOUT DOWNLOADING ANY DOCUMENT. IF YOU ARE ACCEPTING THE TERMS OF THIS AGREEMENT ON BEHALF OF A COMPANY OR OTHER LEGAL ENTITY, YOU REPRESENT AND WARRANT THAT YOU HAVE THE AUTHORITY TO BIND THAT COMPANY OR LEGAL ENTITY TO THE TERMS OF THIS AGREEMENT AND, IN SUCH EVENT, “YOU” WILL REFER TO THAT COMPANY OR LEGAL ENTITY.

IF YOU DO NOT AGREE TO THE TERMS CONTAINED IN THIS AGREEMENT, OR IF YOU DO NOT HAVE THE RIGHT, POWER AND AUTHORITY TO ACT ON BEHALF OF AND BIND SUCH ENTITY, DO NOT SELECT THE “I ACCEPT” BUTTON OR OTHER BUTTON OR MECHANISM DESIGNED TO ACKNOWLEDGE AGREEMENT AND DO NOT DOWNLOAD, OPEN, ACCESS OR OTHERWISE COPY OR USE ALL OR ANY PORTION OF THE DOCUMENT. RENESAS PERMITS YOU TO DOWNLOAD, OPEN, ACCESS, OR OTHERWISE COPY, OR USE THE DOCUMENT ONLY IN ACCORDANCE WITH THIS AGREEMENT.

Therefore, in such event, please destroy all the download files containing the Software immediately.

### Section 1. (Definition)

As used herein, the following terms shall have the meanings set forth below:

- 1.1 “**Program**” means the computer program for the RENESAS LSI as set forth in Appendix A, which contains software originating from RENESAS and its licensors.
- 1.2 “**Documentation**” means the documentation relevant to the Program as set forth in Appendix A.
- 1.3 “**Program Product(s)**” means the Program and the Documentation, collectively.
- 1.4 “**RENESAS LSI**” means RENESAS semiconductor product as set forth in Appendix A.

### Section 2. (License Grant)

- 2.1 Subject to the terms and conditions set forth in this Agreement, RENESAS hereby grants to Customer a personal, non-exclusive, non-transferable, royalty-free, with no rights to sublicense to others, to use the Program for the sole purpose of simulation and design integration on RENESAS LSI.
- 2.2 Customer may delegate any portion of the activities permitted under Section 2.1 above to a third party subcontractor (“**Subcontractor**”) upon prior approval by RENESAS. In the event that Customer causes its Subcontractor to use the Program Product, the Customer shall impose on such Subcontractor the same obligations and restrictions contained in this Agreement and shall remain responsible and liable to RENESAS for the performance of any of such Subcontractor’s compliance with such obligations and restrictions under this Agreement by Customer, including without limitation any breach of such obligations by Subcontractors.
- 2.3 Customer shall not reverse engineer, reverse compile or disassemble the object code portion of the Program.

- 2.4 Customer shall not sublicense, rent, assign, transfer or otherwise dispose of the Program Products and its license to any third party.
- 2.5 Customer shall not alter, remove or delete, and shall reproduce any copyright, patent or other proprietary rights notice or markings contained on or within the Program Products
- 2.6 In addition to the license terms and conditions set forth herein, Customer agrees to comply with the additional license terms and conditions set forth in Appendix B.
- 2.7 Except as expressly provided herein, no rights or licenses shall be granted to Customer in connection with the Program Products.

### **Section 3. (Ownership)**

- 3.1 Nothing contained herein shall transfer or be deemed to transfer to Customer any title, interest or intellectual property rights in Program Products, which shall remain an exclusive property of RENESAS and/or licensor(s) of RENESAS.
- 3.2 The title, interest or intellectual property rights in the modification of the Program created by or for Customer hereunder shall be owned by Customer, subject to the underlying title, interest and/or intellectual property rights in Program Products retained by Renesas and/or licensor(s) of Renesas in accordance with Section 3.1 above.

### **Section 4. (Confidentiality)**

- 4.1 Customer hereby agrees that it shall treat the Program Products and related information (collectively as “**Confidential Information**”) furnished by RENESAS to Customer hereunder as strictly confidential, and shall neither disclose or divulge it, directly or indirectly, to any third party nor use such Confidential Information for any purpose other than the purpose of this Agreement. Customer further agrees that it shall restrict the access to Confidential Information only to its employees who have confidentiality obligations and have a need to know such Confidential Information for the purpose of this Agreement.
- 4.2 Notwithstanding Section 4.1 above, Customer may disclose Confidential Information to its Subcontractors to the extent reasonably necessary for the purpose permitted under Section 2.2 above and in such event, Customer shall enter into a written non-disclosure agreement with each such third party in advance that contains confidentiality and restricted use obligations at least as protective as those contained herein. Customer shall remain responsible and liable to Renesas for such Subcontractor’s compliance with such obligations and restrictions.

### **Section 5. (Warranty Disclaimer)**

CUSTOMER SPECIFICALLY ACKNOWLEDGES AND AGREES THAT THE PROGRAM PRODUCTS ARE PROVIDED “AS IS”. RENESAS AND/OR ITS LICENSORS MAKE NO WARRANTIES OR REPRESENTATIONS (EXPRESS OR IMPLIED, ORAL OR WRITTEN), IN WHOLE OR IN PART WITH RESPECT TO THE PROGRAM PRODUCTS WHICH MAY BE PROVIDED BY RENESAS TO CUSTOMER HEREUNDER, INCLUDING BUT NOT LIMITED TO, WARRANTIES OF MERCHANTABILITY, OR FITNESS OR SUITABILITY FOR ANY PURPOSE (WHETHER OR NOT RENESAS KNOWS, HAS REASON TO KNOW, HAS BEEN ADVISED, OR IS OTHERWISE IN FACT AWARE OF ANY SUCH PURPOSE), WHETHER ALLEGED TO ARISE BY LAW, BY REASON OF CUSTOM OR USAGE IN THE TRADE, OR BY COURSE OF DEALING OR WARRANTY THAT THE USE OF THE PROGRAM PRODUCTS WILL NOT INFRINGE ANY PATENT, COPYRIGHTS OR OTHER INTELLECTUAL PROPERTY RIGHTS OF THIRD PARTIES. TO THE MAXIMUM EXTENT PERMITTED BY APPLICABLE LAWS AND REGULATIONS, IN NO EVENT SHALL RENESAS AND ITS LICENSORS BE LIABLE FOR ANY DAMAGES ARISING OUT OF OR IN CONNECTION WITH THIS AGREEMENT OR ANY CLAIM BY CUSTOMER OR ANY THIRD PARTY ON ACCOUNT OF, OR ARISING FROM THE USE OF PROGRAM PRODUCTS PROVIDED BY RENESAS TO CUSTOMER.

### **Section 6. (Limitation of Liability)**

WITHOUT LIMITING ANY OTHER PROVISIONS IN THIS AGREEMENT, TO THE MAXIMUM EXTENT PERMITTED BY APPLICABLE LAWS AND REGULATIONS, IN NO EVENT SHALL RENESAS AND/OR ITS LICENSORS BE LIABLE TO CUSTOMER (OR ANY PERSON CLAIMING RIGHTS DERIVED FROM CUSTOMER'S RIGHTS) FOR INCIDENTAL, CONSEQUENTIAL, SPECIAL, PUNITIVE, OR EXEMPLARY DAMAGES OF ANY KIND, INCLUDING BUT NOT LIMITED TO, LOST PROFITS, LOSS OF BUSINESS, OR ANY OTHER ECONOMIC DAMAGE, PROPERTY DAMAGE, OR PERSONAL INJURY WHETHER BASED ON BREACH OF ANY TERM OF THIS AGREEMENT, TORT (INCLUDING NEGLIGENCE), PRODUCT LIABILITY OR OTHERWISE, REGARDLESS OF WHETHER RENESAS WAS ADVISED, HAD OTHER REASON TO KNOW, OR IN FACT KNEW OF THE POSSIBILITY THEREOF.

### **Section 7. (Export Control)**

Customer represents and warrants that Customer shall not use the Program Products for the purposes of disturbing international peace and security, including (i) the design, development, production, stockpiling or use of weapons of mass destruction such as nuclear, chemical or biological weapons or missiles, (ii) other military activities, or (iii) any use supporting these activities. Customer also represents and warrants that Customer shall not sell, export, dispose of, license, rent, transfer, disclose or otherwise provide the Program Products to any third party, whether directly or indirectly, with knowledge or reason to know that the third party or any other party will engage in the activities described above. Furthermore, Customer represents and warrants that Customer shall not directly or indirectly, export, re-export, transship or otherwise transfer the Program Products in violation of any applicable export control laws or regulations promulgated and administered by the governments of the countries asserting jurisdiction over the parties or their transactions.

### **Section 8. (Term and Termination)**

- 8.1 This Agreement shall continue in force for twelve (12) months from the date Customer agreed to the terms and conditions of this Agreement (“**Effective Date**”) unless sooner terminated pursuant to Section 8.2.
- 8.2 RENESAS may immediately terminate this Agreement by giving a written notice of termination to Customer:
- (i) if Customer defaults in any of the provisions of this Agreement and does not remedy the default within one (1) month after a written notice is given requesting to remedy the default;
  - (ii) if Customer becomes insolvent or a petition in bankruptcy or for corporate reorganization or for any similar relief is filed by or against Customer, or a receiver is appointed with respect to any of the assets of Customer, or liquidation proceeding is commenced by or against Customer or if in the opinion of the RENESAS the Customer does any act which prejudices its rights; or
  - (iii) if there is a change of control of Customer.
- 8.3 In the event that this Agreement is terminated pursuant to Section 8.1 or 8.2 above, Customer shall promptly take the following steps;
- (i) Customer shall destroy the Program Products and any information regarding the Program Products provided by RENESAS pursuant to this Agreement. Customer also shall not use or provide the Program Products and such information to any third party.
  - (ii) Customer shall promptly submit a certificate of such destruction to RENESAS.

### **Section 9. (Survival)**

The parties agree that the rights and obligations set forth in Sections 2.3, 2.4, 2.5, 2.6, 2.7, 3 through 7, 8.3, and 9 through 13 shall survive the expiration or termination of this Agreement by any reason including Section 8 of this Agreement.

### **Section 10. (Separability)**

If any part to this Agreement is found to be illegal or unenforceable, then such illegal or unenforceable part will be stricken, but the remainder of this Agreement will continue in full force and effect.

### **Section 11. (Governing Law)**

This Agreement shall be governed by the laws of the state of California. Any and all disputes, controversies or claims arising out of or relating to this Agreement that cannot be settled amicably shall be finally settled by the American Arbitration Association under its Commercial Arbitration Rules. The arbitration shall take place in Santa Clara, California and shall be conducted in the English language. The arbitration award shall be final and binding upon the parties hereto and shall not be subject to appeal to court; and judgment on the award may be entered in any court having jurisdiction thereof.

**Section 12. (Assignment)**

Except as expressly provided herein, Customer shall not assign any rights, or subcontract or otherwise delegate any duties, under this Agreement to any third party without the prior written consent of RENESAS. This Agreement shall be binding upon and inure to the benefit of the parties and their respective successors, assigns and legal representatives.

**Section 13. (Entire Agreement)**

This Agreement sets forth the entire agreement of the parties with respect to the subject matter hereof and supersedes any prior or contemporaneous agreements, written or oral, concerning the subject matter hereof. Any change, modification or amendment of the terms of this Agreement shall not be effective unless reduced to writing and authorized by RENESAS.

**Appendix A**

1. Program

Description	Part number	Specified additional license terms
(G274-0) DWC LPDDR5X/5/4X PHY TSMC N3E	-	Appendix-B
(H735-0) DWC UCIe 1TS4 NS TSMC N3E	-	Appendix-B
(G627-0) DWC PCIe 60 NS NCS TSMC N3 X4	-	Appendix-B
(G241-0) DWC eUSB2 PHY TSMC N3E	-	Appendix-B
(H973-0) DWC C20 PHY LP CUREN TSMC N3E X2	-	Appendix-B
(G666-0) DWC MIPI M G5T1 22 TSMC N3E	-	Appendix-B
(G304-0) DWC MIPI CD RX 2T2L 65 TSMCN3E	-	Appendix-B
(G675-0) DWC DP21 TX TSMC N3EP	-	Appendix-B

2. Documentation

Technical documentation for the Program as stated above

3. RENESAS LSI

R-Car Gen5(X5H)

**Appendix B**

Restriction on Use of SYNOPSYS DWC Models

1. The Customer acknowledges that Synopsys, Inc., (“Synopsys”) has certain intellectual property rights in the subjected Program Product;
2. Customer may delegate any portion of the activities permitted under Section 2.2 above to a third party contractor subject to the following: (i) the contractor shall not be the companies as identified in Appendix C (“Competitors”) and (ii) Customer represents and warrants that its contractors are not the Competitors.

**Appendix C**  
**Competitors**

**SYNOPSIS IP COMPETITORS – 【April 2021】**

**【AIS24-0090】**

Achronix  
ACTT  
Alchip  
Alphawave  
Algo-Logic Systems  
Analog Bits, Inc.  
Analog X  
Analogix Semiconductor, Inc.  
Andes Technology  
Aragio Solutions  
Arasan Chip Systems Inc.  
Arastu Systems  
ARM Holdings, A Softbank company  
ARM China  
Arteris  
ArterisIP  
Atria  
Attopsemi Technology  
Aura Semiconductor  
Authentec  
Beyond Semiconductor  
Brite  
Cadence Design Systems, Inc.  
CAST, Inc.  
Certus Semiconductor  
Ceva, Inc.  
Chingis Technology Corporation  
Chip Memory Technology  
Chips & Media  
ChuangFeiXin Technology  
Cobham Gaisler  
Codasip  
CoMira Solutions  
Cortus  
Cortus S.A.  
CloudBEAR  
Credo  
Credo Semiconductor  
CRI, a Rambus company  
CSEM  
Digital Blocks  
Digital Core Design  
Digital Media Professionals  
Dolphin Design  
Dolphin Integration SA  
Dolphin Technology, Inc.  
Dolphin Technology Vietnam  
Dxcorr Design  
eMemory Technology, Inc. (EMTC)  
Empyrean  
Eureka Technology, Inc.  
Extoll  
Faraday Technology Corporation  
Flex Logix  
Fraunhofer IIS  
GDA Technologies, Inc.  
Global UniChip  
Guoqi  
GTA Semi  
Himax Media Solutions  
Imagination Technologies  
Innopower  
Innosilicon  
Innovative Semiconductors, Inc.  
Inside Secure  
InPsytech  
IP Cores, Inc.  
IP Goal  
IPextreme  
IQ Analog  
ITE Tech  
L&T Infotech Ltd.  
Legend Design Technology  
Library Technologies

**【AIS24-0090】**

LTTS  
M31  
Maxvi  
Menta  
Mentor Graphics, a Siemens Company  
Microsemi  
Mindtree  
MIPS  
Mixel  
Mobiveil  
Mocana  
MoreThanIP  
MorethanIP GmbH  
MosChip  
MoSys, Inc.  
Naneng Microelectronics  
Nangate  
NanoSilicon  
Northwest Logic, Inc.  
Novocell Semiconductor  
NSCore, Inc.  
Nuclei  
OpenFive  
Open Security Research  
OmniDesign  
OmniPhy  
Precise-ITC, Inc  
Perftrends  
PLD Applications  
PLDA  
PrimeSoC Technologies  
QualCore Logic  
Rambus Inc.  
Rianta Solutions, Inc  
Samoff  
Sankalp Semiconductor  
Savarti  
Semtech

**【AIS24-0090】**

SiFive  
Silex Insight  
Silicon Creations  
Silicon Design Solutions, Inc.  
Silicon Image, Lattice Semiconductor  
Silicon Library, Inc.  
SmartDV  
Socle Technology Corp.  
Soft Mixed Signal Corp  
Sonics  
Spectral Design & Test  
SST  
sureCore  
Silvaco (IP Extreme)  
SyntaCore  
T2M  
T-Head  
Takumi Corporation  
Tamba Networks  
TaraCom  
Tata Elxsi  
Techno Mathematical Company (TMC)  
Tela Innovations  
Terminus Circuits  
Tiempo  
True Circuits, Inc.  
TTT Tech  
Ubiquitous Technologies  
Uniquify, Inc.  
Velocitytech  
Verisilicon  
VinChip Systems Inc.  
Vivante – a VeriSilicon company  
VSI  
Wave Computing  
Waves Computing (MIPS)  
Yield Microelectronics Corporation